

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Richard H. Lane

Application No.: Not Yet Assigned

Group Art Unit: 2814

Filed: November 21, 2001

Examiner: T. Doan

For: METHOD OF PATTERNING NOBLE
METALS FOR SEMICONDUCTOR
DEVICES BY ELECTROPOLISHING

FIRST PRELIMINARY AMENDMENT

Box Non-Fee Amendment

Commissioner for Patents
Washington, DC 20231

Dear Sir:

Prior to examination on the merits, please amend the above-identified U.S.
patent application as follows:

In the Specification

On page 2, before "Field of Invention," please insert --This application is a
divisional of application Serial No. 09/639,089, filed on August 16, 2000, which is
incorporated herein by reference.--

In the Claims

Please cancel claims 1-28.

REMARKS/ARGUMENTS

The specification has been amended to include a reference to prior application Serial No. 09/639,089, filed on August 16, 2000, as required by 37 CFR 1.78(a)(2).

Claims 1-28 have been canceled. The pending application now contains claims 29-54.

Allowance of the application is solicited.

Dated: November 21, 2001

Respectfully submitted,

By 

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